

4 Channel Low Capacitance ESD Protection Diode Array

HYESD0524 is a 4-channel ultra low capacitance ESD protection diode array which includes surge rated to protect high speed data lines. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail. Typical application, the negative rail pin (Assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage.

FEATURES

- 4 Channel ESD protection for high speed data line
- Provides ESD protection to IEC61000-4-2 level 4
 - $\pm 17\text{KV}$ Air Discharge
 - $\pm 12\text{KV}$ Contact Discharge
- Ultra low capacitance
 - I/O to GND : 0.9pF (Max)
 - I/O to I/O : 0.45pF (Max)
- Low clamping voltage & 5V operation voltage

APPLICATION

- HDMI / DVI ports
- Display port
- USB 2.0 port
- Flat panel Monitors / TVs
- Cellular Handsets & Accessories
- PCI Express
- Serial ATA

MECHANICAL INFORMATION

- Case : SOT-23-6L / SOT-363-6L Package
- Pb-Free, Halogen Free, RoHS/WEEE Compliant

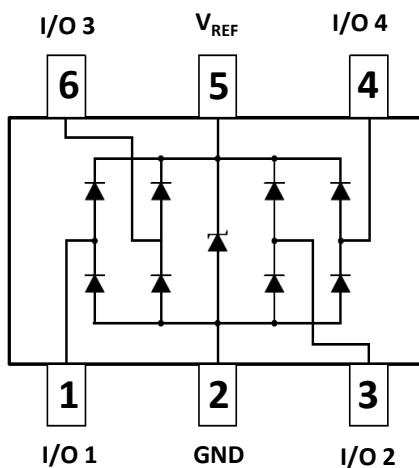


HYESD0524A6
SOT-23-6L



HYESD0524B6
SOT-363-6L

PIN CONFIGURATION



Maximum Rating and Thermal Characteristics ($T_C=25^\circ\text{C}$)

| Parameter | Symbol | Value | Unit |
|--------------------------------|-----------|-------------------|------------------|
| Peak Pulse Power(8/20μs) | P_{PP} | 150 | W |
| Peak Pulse Current(8/20μs) | I_{PP} | 5 | A |
| ESD per IEC 61000-4-2(Air) | V_{ESD} | $\pm 17\text{KV}$ | V |
| ESD per IEC 61000-4-2(Contact) | V_{ESD} | $\pm 12\text{KV}$ | V |
| Operating Temperature Range | T_{op} | -55 to +125 | $^\circ\text{C}$ |
| Storage Temperature Range | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

Electrical Characteristics ($T_C=25^\circ\text{C}$, unless otherwise noted)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
|--|-----------|---|-----|------|------|------|
| Reverse Working Voltage | V_{RWM} | Any I/O pin to GND | - | - | 5 | V |
| Reverse Breakdown Voltage | V_{BR} | $I_{BR} = 1\text{mA}$; I/O pin to GND | 6 | - | | V |
| Reverse Leakage Current | I_R | $V_{RWM} = 5\text{V}$, $T = 25^\circ\text{C}$; I/O pin to GND | - | - | 1 | uA |
| Positive Clamping Voltage | V_C | $I_{PP}=1\text{A}$, $t_p=8/20\mu\text{s}$; Positive pulse; Any I/O pin to GND | - | 8.5 | 12 | V |
| Negative Clamping Voltage | V_C | $I_{PP}=1\text{A}$, $t_p=8/20\mu\text{s}$; Negative pulse; Any I/O pin to GND | - | 1.8 | - | V |
| Junction Capacitance Between Channel | C_J | $V_R=0\text{V}$, $f=1\text{MHz}$; Between I/O pins | - | 0.35 | 0.45 | pF |
| Junction Capacitance Between I/O And GND | C_J | $V_R=0\text{V}$, $f=1\text{MHz}$; Any I/O pin to GND | - | - | 0.9 | pF |

RATING AND CHARACTERISTIC CURVES
HYESD0524A6 / HYESD0524B6

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Typical Characteristic Curves ($T_J=25^\circ\text{C}$, UNLESS OTHERWISE NOTED)

FIG.1 - Power Derating Curve

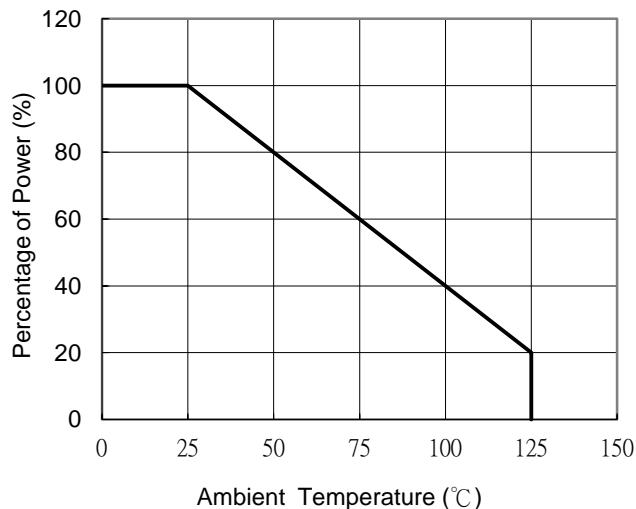


FIG.2 - Pulse Waveform

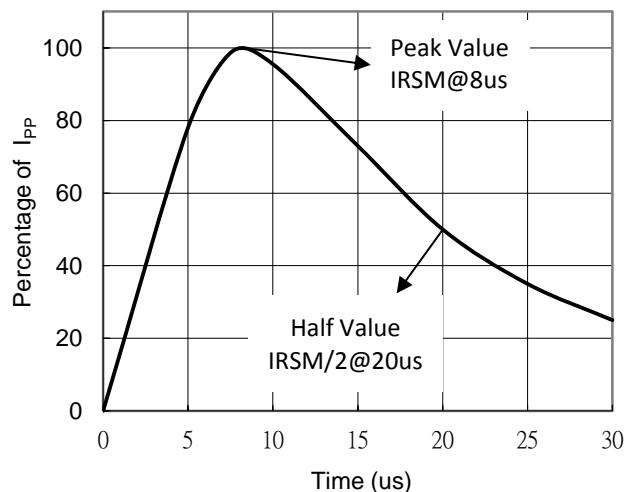


FIG.3 - Junction Capacitance vs. Reverse Voltage

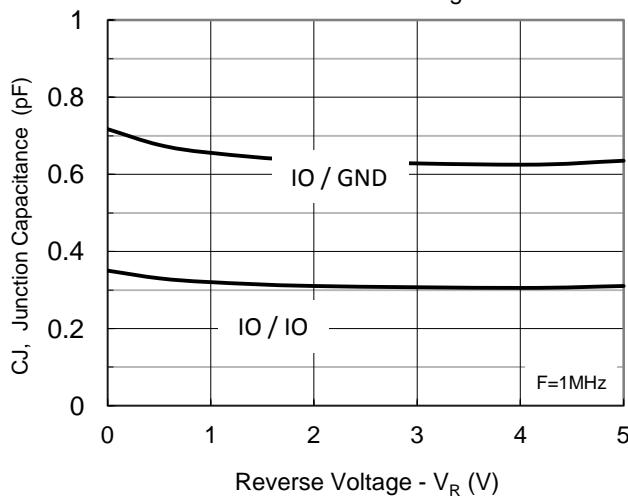
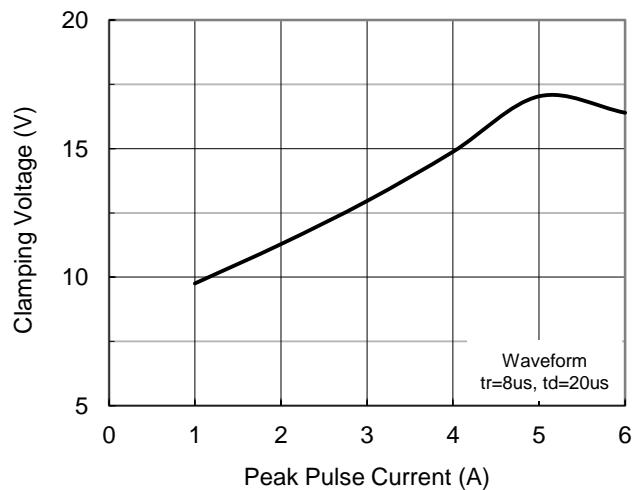
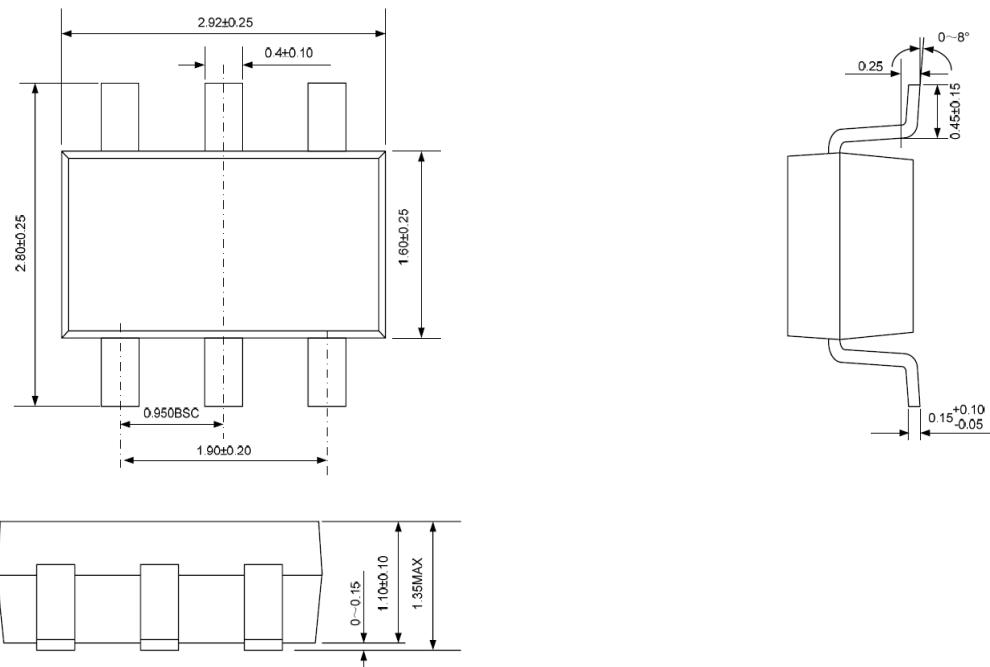


FIG.4 - Clamping Voltage vs. Peak Pulse Current



Order & Marking Information

| Part Number | Package | Marking | Packing | Q'ty |
|-------------|------------|---------|---------|------|
| HYESD0524A6 | SOT-23-6L | 24A6 | 7" Reel | 3K |
| HYESD0524B6 | SOT-363-6L | 24B6 | 7" Reel | 3K |

Package Outline Dimension**SOT-23-6L Package****SOT-363-6L Package**